

PATENT ASSIGNMENT

SUBMISSION TYPE: NEW ASSIGNMENT

APPLICATION NUMBER
10/065552

NATURE OF CONVEYANCE: ASSIGNMENT OF ASSIGNOR'S INTEREST

CONVEYING PARTY DATA

Name: Sawada, Shigeru

Execution Date: 10/16/2002

Name: Iwasaki, Takashi

Execution Date: 10/16/2002

RECEIVING PARTY DATA

Name: Sumitomo Electric Industries, Ltd.

Street Address: 5-33, Kitahama 4-chome, Chuo-ku

Internal Address:

City: Osaka-shi

State:

Country: JAPAN

Postal Code: 541-0041

The USPTO, Office of Public Records, will send correspondence via facsimile to **FAX NUMBER:** 1-360-358-6839

CORRESPONDENCE DATA:

Correspondence will be sent via US Mail when a fax number

has not been provided or the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 029453

NAME OF PERSON SIGNING: James Judge

DATE SIGNED: 10/30/2002

Total Attachments: 1

OP \$40.00 10065552

ASSIGNMENT OF PATENT APPLICATION

Whereas, Shigeru SAWADA and Takashi IWASAKI

citizen(s) of Japan and hereinafter referred to as the applicant, has invented certain new and useful improvements in

WAFER INCLUDING AN In-CONTAINING-COMPOUND SEMICONDUCTOR SURFACE LAYER, AND METHOD FOR PROFILING ITS CARRIER CONCENTRATION

- for which the applicant executed an application for United States Patent on the latest date next to the signature(s) below,
- for which United States Patent Application Number _____ / _____ was filed on _____,

and whereas, Sumitomo Electric Industries, Ltd., a corporation organized and existing under the laws of Japan and

hereinafter referred to as the assignee, whose mailing address is

5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka, 541-0041 Japan

is desirous of acquiring the entire rights in the patent application named above, and insofar as the same yields any United States patent(s), the title to and interest in the same:

Now, therefore, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the applicant assigns, and transfers, unto the assignee, the entire rights in the patent application, and the title to and interest in the same insofar as the same yields any United States patent(s); and the applicant hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all any such patent(s) to the assignee, as that of the entire title to and interest in any such patent(s), for the sole use and behoof of the assignee and the assignee's legal representatives, as fully and entirely as any such patent(s) would have been held by the applicant had the present assignment not been made.

In testimony whereof the applicant(s) have below executed this assignment.

Signature(s) and date(s):

<u>Shigeru Sawada</u>	<u>Oct. 16. 2002</u>
<u>Takashi Iwasaki</u>	<u>Oct. 16. 2002</u>